

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

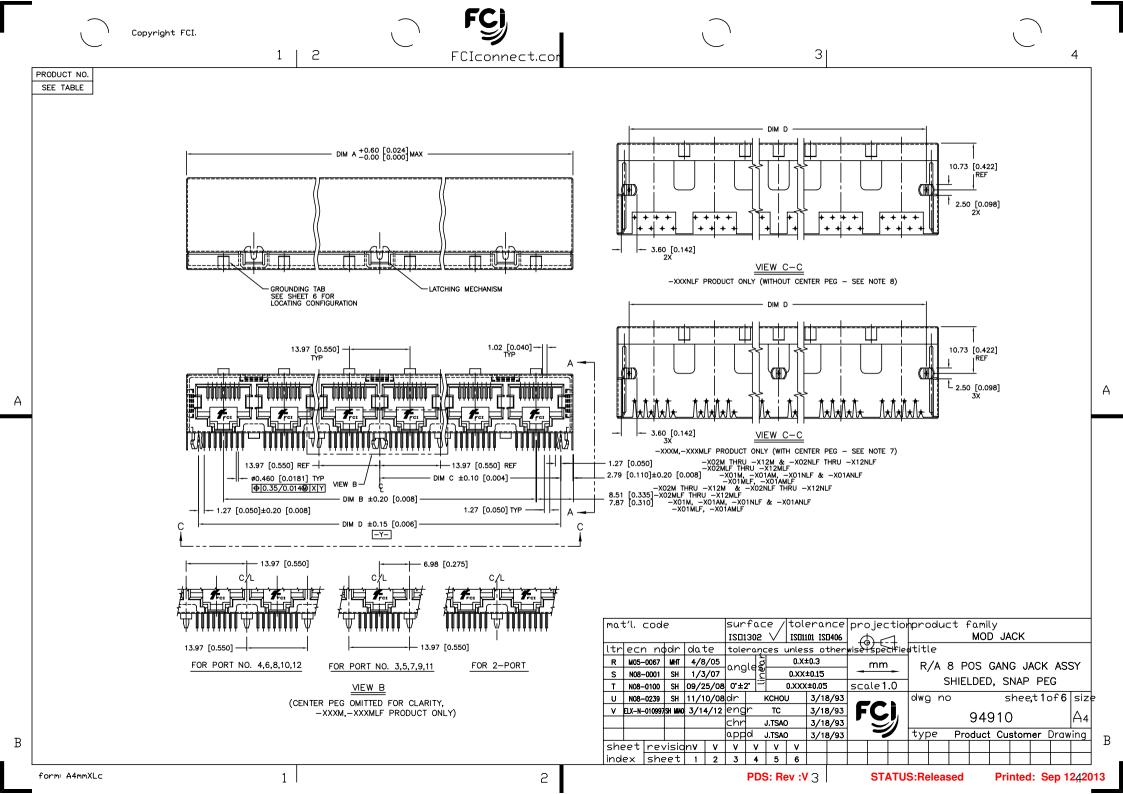
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









3.05 [0.12] REF. -

NO BOTTOM SPRING

SIDE PEG

0.27+0.23

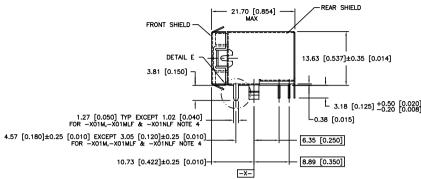
( BOTTOM SPRING

WAS BEND BACK)

3.95

REF.

3.00<sup>+0.95</sup>



NO MORE THAN 5' BEND OUT

0.27 + 0.23

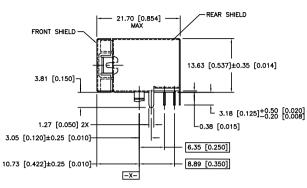
REAR PEG

P/N-X03N-ALF ONLY

2.50<sup>+2.76</sup> -0.50

DETAIL C

SCALE: 3/1



### VIEW A-A

#### NOTE 5

NOTES:

- 1. RECOMMENDED P.C.B. THICKNESS 1.60 [0.063].
- 2. CONTACTS: PHOS BRONZE ALLOY UNS-C51000, Ø 0.460 [0.0181] ROUND WIRE, PLATING SEE TABLE.
- (3) SHIELDING MAT'L: .25 [0.010] THICK BRASS ALLOY. SHIELDING PLATING: FOR 94910-XXXM: 2.54uM/100u" MIN BRIGHT TIN-LEAD PLATED OVER 0.76uM/30u" MIN NICKEL UNDERPLATING PER BUS-15-002/M. LEAD FREE OPTION: FOR 94910-XXXNLF: 0.76uM/30u" MIN NICKEL PLATING, WITH SELECTIVE TIN ON SOLDER TAILS, SEE DETAIL É. SHIELDING PLATING: FOR 94910-XXXMLF: 2.54uM/100u" MIN BRIGHT PURE TIN PLATED OVER 0.76uM/30u" MIN NICKEL UNDERPLATING PER BUS-15-002/M.
- (4) SPECIALLY FOR ONE-PORT P/N 94910-X01M,-X01MLF & 94910-X01NLF ONLY. SOLDER TAIL OF SHIELD IS 1.02 [0.040] WIDE, DISTANCE FROM PCB PEG TO THE SOLDER TAIL IS 3.05 [0.120].
- (5) SPECIALLY FOR ONE-PORT P/N 94910-X01AM,-X01AMLF& 94910-X01ANLF ONLY. SOLDER TAIL OF SHIELD IS 1.27 [0.050] WIDE, DISTANCE FROM PCB PEG TO THE SOLDER TAIL IS 3.05 [0.120].
- 6. ALL DIMENSIONS IN MILLIMETERS/INCHES.
- (7.) CENTER PEG FOR 8-PORTS AND ABOVE, (-XXXM,-XXXMLF PRODUCT ONLY).
- (8.) NO CENTER PEG AVAILABLE ON -XXXNLF PRODUCT.
- (9) 'LF" SUFFIX AT THE END OF PART NUMBER IS LEAD FREE.
- 10. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 15 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.5mm MINIMUM THICK CIRCUIT BOARD. SEE APLICATION NOTES/PROCEDURES IF THEY ARE AVAILABLE.
- 11. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008
- (12.) PLATING OPTIONS:
- MAY BE EITHER GOLD OR GXT PLATED AT MANUFACTURER'S OPTION.

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В

form: A4mmXLc

PDS: Rev :V 3

STATUS:Released

Printed: Sep 1242013

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						. 0120111122	
PRODUCT No.	No. OF PORTS	DIM A +0.60 [0.024]	DIM B	DIM C±0.10 [0.004]	DIM D±0.15 [0.006]	GROUND LEG NO. ON THE BACK (VIEW B)	NOTE
94910-X01M	1	15.74 [0.620]		5.72 [0.225]	11.43 [0.450]	NONE	NOTE 4
94910-X01AM	1	15.74 [0.620]		5.72 [0.225]	11.43 [0.450]	NONE	NOTE 5
94910-X04M	4	58.92 [2.320]	41.91 [1.650]	26.67 [1.050]	53.34 [2.100]	3	
94910-X08M	8	114.80 [4.520]	97.79 [3.850]	54.61 [2.150]	109.22 [4.300]	3	
94910-X01MLF	1	15.74 [0.620]		5.72 [0.225]	11.43 [0.450]	NONE	NOTE 4
94910-X01AMLF	1	15.74 [0.620]		5.72 [0.225]	11.43 [0.450]	NONE	NOTE 5
94910-X04MLF	4	58.92 [2.320]	41.91 [1.650]	26.67 [1.050]	53.34 [2.100]	3	
94910-X08MLF	8	114.80 [4.520]	97.79 [3.850]	54.61 [2.150]	109.22 [4.300]	3	
94910-X11MLF	1	15.74 [0.620]		5.72 [0.225]	11.43 [0.450]	NONE	NOTE 4
94910-X11AMLF	1	15.74 [0.620]		5.72 [0.225]	11.43 [0.450]	NONE	NOTE 5
94910-X14MLF	4	58.92 [2.320]	41.91 [1.650]	26.67 [1.050]	53.34 [2.100]	3	
94910-X18MLF	8	114.80 [4.520]	97.79 [3.850]	54.61 [2.150]	109.22 [4.300]	3	

O: MEETS WAVE SOLDER PROCESS PRODUCT NO.

1: MEETS PIP PROCESS PRODUCT NO.

PLATING CODE X	PLATING 12
0	5u" Au + high performance lubricant
1	.38uM/15u" GOLD
3	5u" Au + high performance lubricant
5	1.27uM/50u" GOLD

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form: A4mmXLc

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PRODUCT No.	PORTS	DIM A -0	DIM B±0.20 [0.008]	DIM C±0.10 [0.004]	DIM D±0.15 [0.006]	THE BACK (VIEW B)	
94910-X01NLF	1	15.74 [0.620]		5.72 [0.225]	11.43 [0.450]	NONE	NOTE 4
94910-X01ANLF	1	15.74 [0.620]		5.72 [0.225]	11.43 [0.450]	NONE	NOTE 5
94910-X04NLF	4	58.92 [2.320]	41.91 [1.650]	26.67 [1.050]	53.34 [2.100]	3	
94910-X08NLF	8	114.80 [4.520]	97.79 [3.850]	54.61 [2.150]	109.22 [4.300]	3	
94910-X11NLF	1	15.74 [0.620]		5.72 [0.225]	11.43 [0.450]	NONE	NOTE 4
94910-X11ANLF	1	15.74 [0.620]		5.72 [0.225]	11.43 [0.450]	NONE	NOTE 5
94910-X14NLF	4	58.92 [2.320]	41.91 [1.650]	26.67 [1.050]	53.34 [2.100]	3	
94910-X18NLF	8	114.80 [4.520]	97.79 [3.850]	54.61 [2.150]	109.22 [4.300]	3	

- 0: MEETS WAVE SOLDER PROCESS PRODUCT NO.

1: MEETS PIP PROCESS PRODUCT NO.

PLATING CODE X	PLATING 12
0	.76uM/30u" G.X.T.
1	.38uM/15u" GOLD
3	5u" Au + high performance lubricant
5	1.27uM/50u" GOLD

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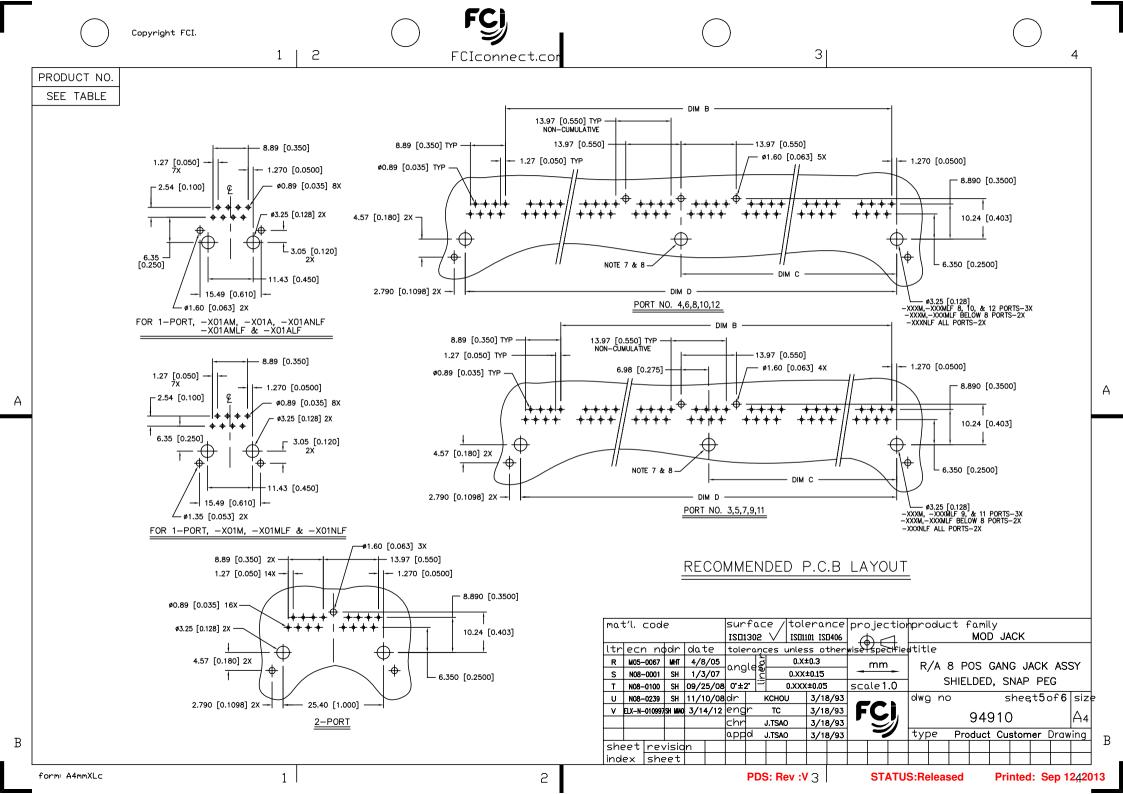
form: A4mmXLc

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PDS: Rev :V3

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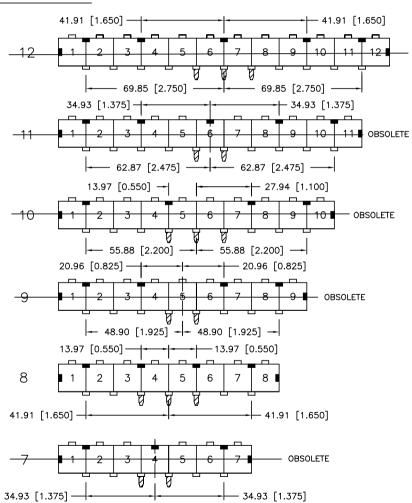


- INDICATES LATCHING TAB (SEE SHEET 1 )
- INDICATES GROUNDING TAB ON THE FRONT OF PRODUCT (SEE SHEET 1 )
- INDICATES GROUNDING LEG ON THE BACK OF PRODUCT (VIEW B)

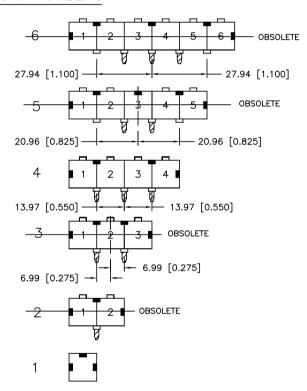
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# PORT NUMBERS



## PORT NUMBERS



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